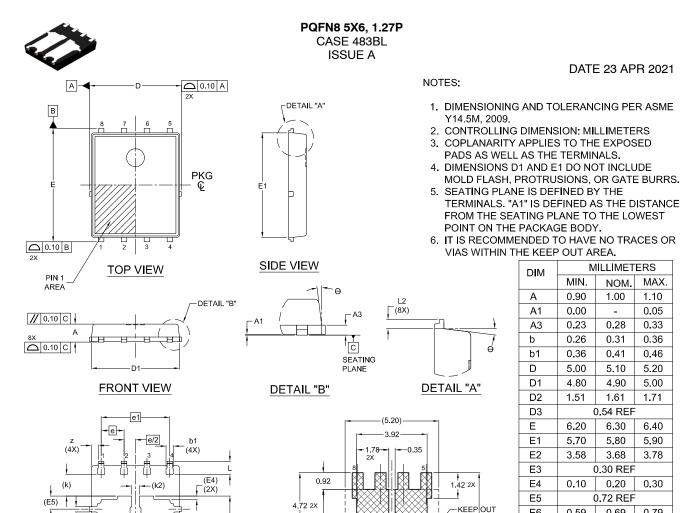
## **MECHANICAL CASE OUTLINE**

**DATE 23 APR 2021** 



E2 (2X)

◆ 0.10**(M)** C A B 0.05**(M)** C

-(D3)

b (8X)

IE KEEF	OUTA	KEA.		
DIM	MILLIMETERS			
	MIN.	NOM.	MAX.	
Α	0.90	1.00	1.10	
A1	0.00	-	0.05	
A3	0.23	0.28	0.33	
b	0.26	0.31	0.36	
b1	0.36	0.41	0.46	
D	5.00	5.10	5.20	
D1	4.80	4.90	5.00	
D2	1.51	1.61	1.71	
D3	0.54 REF			
Е	6.20	6.30	6.40	
E1	5.70	5.80	5.90	
E2	3.58	3.68	3.78	
E3	0.30 REF			
E4	0.10	0.20	0.30	
E5	0.72 REF			
E6	0.59	0.69	0.79	
е	1.27 BSC			
e1	3.81 BSC			
e/2	0.635 BSC			
k	1.19 REF			
k1	0.60 REF			
k2	0.45 REF			
L	0.64	0.74	0.84	
L2	0.15	0.25	0.35	
z	0.39 REF			
Θ	0°	_	7°	

*FOR ADDITIONAL INFORMATION ON OUR
PB-FREE STRATEGY AND SOLDERING
DETAILS, PLEASE DOWNLOAD THE ON
SEMICONDUCTOR SOLDERING AND
MOUNTING TECHNIQUES REFERENCE
MANUAL, SOLDERRM/D.

LAND PATTERN RECOMMENDATION

1.27

AREA

0.77

1 27

6.91

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DESCRIPTION:	PQFN8 5X6, 1.27P		PAGE 1 OF 1	

3.80.2x

1.42 4X

0.61

0.635

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(2X)

E6 (4X)

(k1)

D2

**BOTTOM VIEW**